



ABS

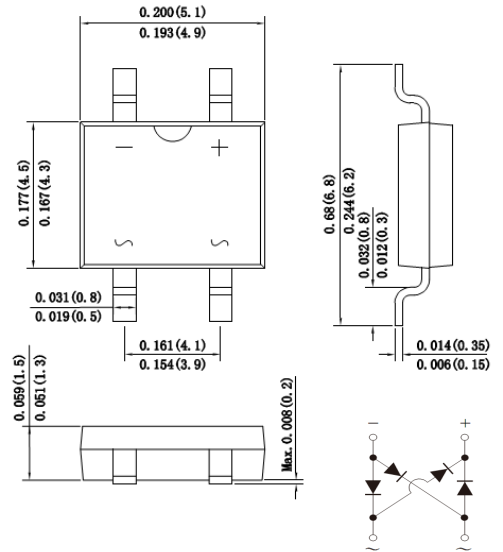


Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Idea for printed circuit board
- Glass passivated Junction chip
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed
- 250°C/10 seconds at terminals

Mechanical Data

- Case** : Molded plastic body
- Terminals** : Solder plated, solderable per MIL-STD-750,Method 2026
- Polarity** : Polarity symbol marking on body
- Mounting Position** : Any
- Weight** : 0.0034 ounce, 0.098 grams



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	ABS2	ABS4	ABS6	ABS8	ABS10	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L=100^\circ C$ On glass-epoxy P.C.B (Note 1)	$I_{(AV)}$	1.0					A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	35.0					A
Rating for fusing ($t=8.3ms, T_A=25^\circ C$)	I_t^2	5.08					A_s^2
Maximum instantaneous forward voltage at 1.0A	V_F	1.10					V
Maximum DC reverse current $T_A = 25^\circ C$ at rated DC blocking voltage $T_A = 125^\circ C$	I_R	5.0 500					μA
Typical junction capacitance (Note 2)	C_J	16.0					pF
Typical thermal resistance	R_{qJA}	80.0					$^\circ C/W$
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150					$^\circ C$

Note:1. Mounted on glass epoxy PC board with 1.3*1.3mm solder pad
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.



Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

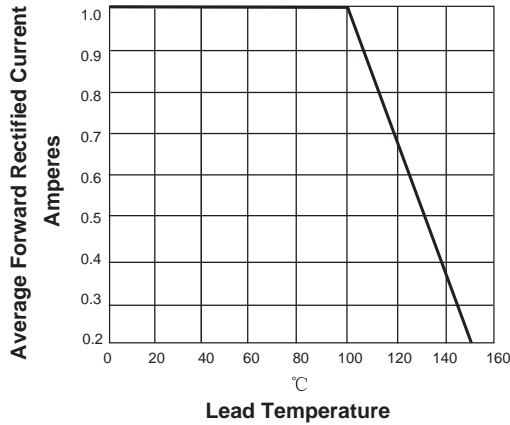


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

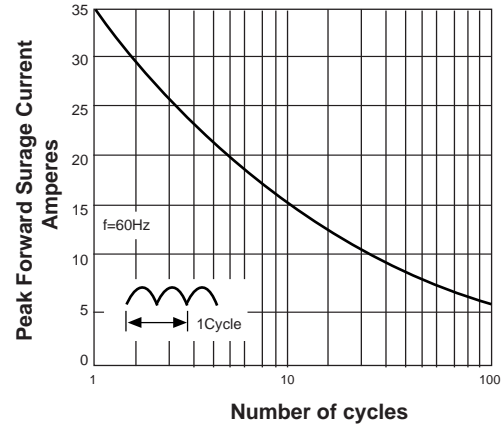


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

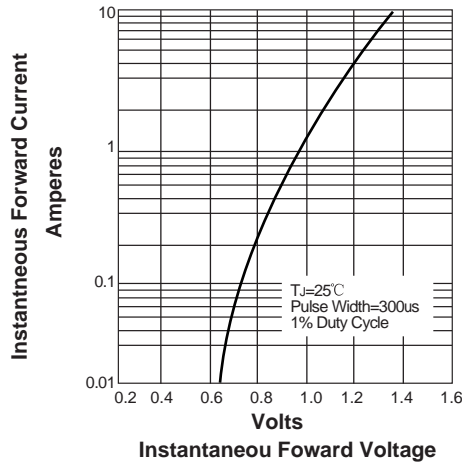
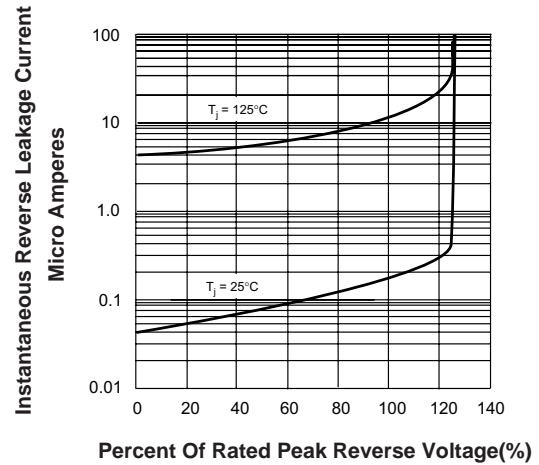
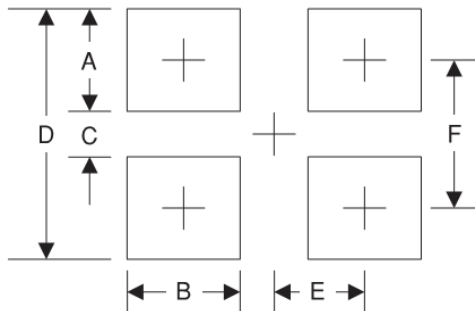


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.5	0.059
B	1.0	0.039
C	4.22	0.166
D	7.22	0.284
E	2.0	0.078
F	5.70	0.224

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